

User manual

Getting started with X-NUCLEO-53L1A2 long distance ranging and multi target ToF sensor expansion board based on VL53L1 for STM32 Nucleo

Introduction

This document provides detailed hardware information on the X-NUCLEO-53L1A2 expansion board. This expansion board is compatible with the STM32 Nucleo family and the Arduino™ electronic boards. It is designed around the VL53L1 long distance ranging sensor with multi target detection, and is based on the ST patented FlightSense technology.

To allow the user to validate the VL53L1 in an environment as close as possible to its final application, the X-NUCLEO-53L1A2 expansion board is delivered with a holder in which three different height spacers of 0.25 mm, 0.5 mm, and 1 mm can be fitted with the cover glass above the spacer. The height spacers are used to simulate different air gap distances between the VL53L1 sensor and the cover glass.

The X-NUCLEO-53L1A2 expansion board is delivered with two VL53L1 breakout boards.



Figure 1. X-NUCLEO-53L1A2 expansion board, spacers, cover glass, and breakout boards



UM2759 - Rev 2 page 2/18



1 Overview

The X-NUCLEO-53L1A2 expansion board features the VL53L1 long distance ranging sensor with multi target detection, based on ST's FlightSense, Time-of-Flight (ToF) technology.

It is compatible with the STM32 Nucleo development board family, and with the Arduino UNO R3 connector lavout.

Several ST expansion boards can be stacked through the Arduino connectors, which allows, for example, the development of VL53L1 applications with Bluetooth or Wi-Fi interfaces.

The X-NUCLEO-53L1A2 expansion board is delivered with:

- Three spacers of 0.25 mm, 0.5 mm, and 1 mm height, used to simulate different air gaps between the VL53L1 and the cover glass.
- Two cover windows to simulate the integration of the VL53L1 into the customer's final product.
- Two VL53L1 breakout boards which can be plugged onto the X-NUCLEO-53L1A2 expansion board or connected through flying wires to the X-NUCLEO-53L1A2 expansion board.
- Two 10-pin connectors to enable the customer to connect the two breakout boards onto the X-NUCLEO-53L1A2 expansion board.

Note:

The VL53L1 is delivered with a liner to prevent potential foreign material from penetrating inside the module holes during the assembly process. This liner must be removed at the latest possible step during final assembly, before module calibration.

Table 1. Ordering information

Order code	Description
X-NUCLEO-53L1A2	STM32 Nucleo expansion board - spacers and glass - two breakout boards

UM2759 - Rev 2 page 3/18



2 Document references

Table 2. Document references

Description	Docid
VL53L1 datasheet	DS11786
X-NUCLEO-53L1A2 data brief	DB4214
P-NUCLEO-53L1A2 data brief	DB4261
X-CUBE-53L1A2 data brief	DB4252

UM2759 - Rev 2 page 4/18



3 X-NUCLEO-53L1A2 expansion board

This section describes the X-NUCLEO-53L1A2 expansion board features and provides useful information for understanding the electrical characteristics.

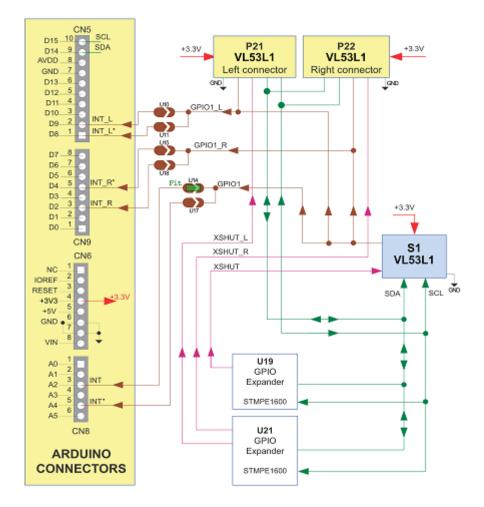


Figure 2. X-NUCLEO-53L1A2 expansion board schematic diagram

UM2759 - Rev 2 page 5/18



3.1 Description

The board allows the user to test the VL53L1 functionality, to program it and to understand how to develop an application using the VL53L1. It integrates:

- 2.8 V regulator to supply the VL53L1
- Level translators to adapt the I/O level to the main board of the microcontroller
- Arduino UNO R3 connectors
- Optional VL53L1 breakout board connectors
- · Solder drops to allow different configurations of the expansion board

It is fundamental to program a microcontroller to control the VL53L1 through the I2C bus. The application software and an example of the C-ANSI source code are available on www.st.com/VL53L1.

The X-NUCLEO-53L1A2 expansion board and STM32 Nucleo development board are connected through the Arduino UNO R3 connectors CN5, CN6, CN8, and CN9 as shown in Figure 3. X-NUCLEO-53L1A2 expansion board connector layout and as described in Table 3. Left Arduino connector and Table 4. Right Arduino connector.

The X-NUCLEO-53L1A2 must be plugged onto the STM32 Nucleo development board through the Arduino UNO R3 connectors.

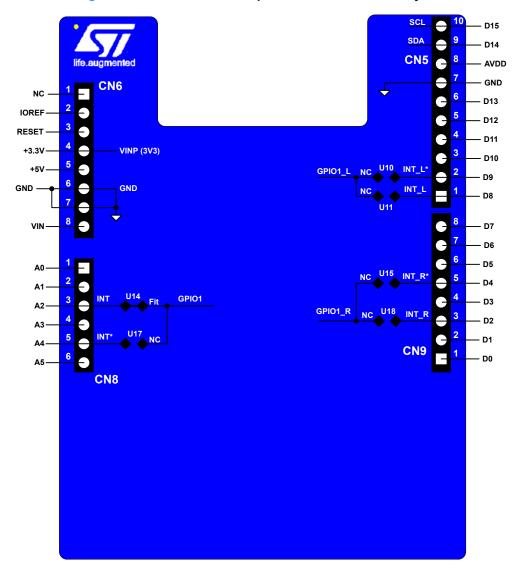


Figure 3. X-NUCLEO-53L1A2 expansion board connector layout

UM2759 - Rev 2 page 6/18



Table 3. Left Arduino connector

CN number	VL53L1 board	Pin number	Pin name	MCU pin	X-NUCLEO-53L1A2 expansion board function	
		1	NC	NC		
		2	NC	IOREF	Notuced	
		3	NC	RESET	Not used	
CNC marrier	Power	4	3V3	3V3	3.3 V supply	
CN6 power		5	NC	5V	Not used	
	Gnd	6	Gnd	Gnd	Cnd	
	Gnd	7	Gnd	Gnd	Gnd	
		8	NC	VIN		
		1	NC	PAO	Not used	
		2	NC	PA1		
	GPIO1	3	INT	PA4	Interrupt signal from VL53L1 on board soldered device	
CN8 analog		4	NC	PB0	Not used	
	GPIO1	5	INT	PC1 ⁽¹⁾	By default not used, interrupt signal from VL53L1 on board soldered device	
		6	NC	PC0	Not used	

Depends on STM32 Nucleo board solder bridges, see details in Section: Solder drop configurations. These interrupt signals are duplicated, but not used. This offers hardware connection flexibility in case of conflict on the MCU interface management when the expansion board is used superimposed with other expansion boards. In this case, remove the solder drop from the used interrupt and instead, fit the solder drop in "NC".

UM2759 - Rev 2 page 7/18



Table 4. Right Arduino connector

CN number	VL53L1 board	Pin number	Pin name	MCU pin	X-NUCLEO-53L1A2 expansion board function	
	SCL	10	D15	PB8	I2C1_SCL	
	SDA	9	D14	PB9	I2C1_SDA	
		8	NC	AVDD	Not used	
	Gnd	7	Gnd	Gnd	Gnd	
		6	INT_L	PA5		
CN5 digital		5	NC	PA6	Not used	
		4	NC	PA7	- Not used	
		3	NC	PB6		
	GPIO1_L	2	INT_L	PC7	By default not used, interrupt signal from optional VL53L1 le breakout board (1)	
	GPIO1_L	1	INT_L	PA9		
CN9 digital		8	NC	PA8		
		7	NC	PB10	Not used	
		6	NC	PB4		
		5	INT_R	PB5	By default not used, interrupt signal from optional VL53L1 rig breakout board (1)	
		4	NC	PB3	Not used	
		3	INT_R	PA10	By default not used, interrupt signal from optional VL53L1 rigl breakout board (1)	
		2	NC	PA2	Netwood	
		1	NC	PA3	Not used	

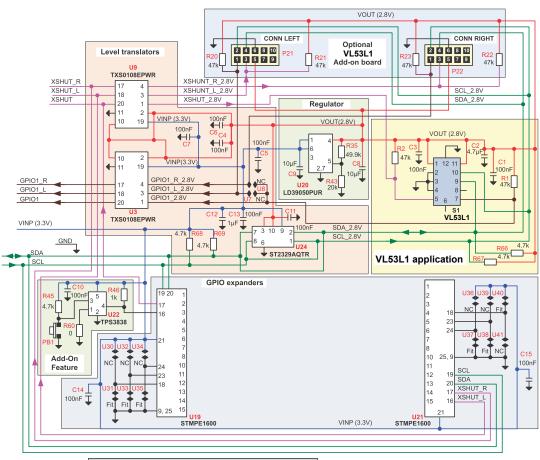
^{1.} These interrupt signals are duplicated, but not used by default. This offers hardware connection of the breakout board VL53L1 interrupt signals and flexibility in case of conflict on the MCU interface management when the expansion board is used superimposed with other expansion boards. In this case, select, through a solder drop, the MCU port which is free.

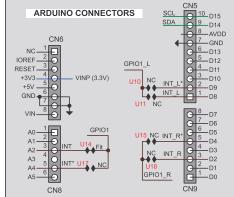
UM2759 - Rev 2 page 8/18



3.2 Electrical schematic

Figure 4. X-NUCLEO-53L1A2 expansion board schematic





VL53L1					
AVDDVCSEL	1	12	GND4		
AVSSVCSEL	2	11	AVDD		
GND	3	10	SCL		
GND2	4	9	SDA		
XSHUT	5	8	DNC		
GND3*	6	7	GPIO1		

^{*} Can be NC or grounded

UM2759 - Rev 2 page 9/18



3.3 List of materials

Table 5. List of materials

Components	Value	Reference	Supplier	Comments			
VL53L1 application							
C1, C3	100 nF	X5R		Cumply wellers describes			
C2	4.7 µF	X5R - 6.3 V		Supply voltage decoupling			
R1	47 k			Interrupt output pull up			
R2	47 k			Reset input pull up			
R66, R67	4.7 k			SDA and SCL line pull up at 2.8 V			
S1		VL53L1	ST	ToF ranging sensor			
		VL53L1 breakout boa	rd interfaces				
R20	47 k			Left breakout board interrupt output pull up			
R21	47 k			Left breakout board reset input pull up			
R22	47 k			Right breakout board reset input pull up			
R23	47 k			Right breakout board interrupt output pull up			
		2.8 V regulator ap	plication				
C8	10 μF	X5R - 6.3 V		Output voltage decoupling			
C9	10 μF	X5R - 6.3 V		Input voltage decoupling			
R35	49.9 k			Feedback resistor bridge to set the			
R43	20 k			output voltage to 2.8 V			
U20		LD39050PUR	ST	Output programmable regulator			
		Level translator a	oplication				
C4, C6, C11	100 nF			2.8 V decoupling capacitor			
C5, C7, C13	100 nF			3.3 V decoupling capacitor			
C12	1 μF	X5R - 6.3V					
R68, R69	4.7 k			SDA and SCL line pull up at 3.3 V			
U3, U9		TXS0108PWR	TI	For all signals except I2C interface			
U24		ST2329AQTR	ST	For I2C interface			
		Add-on feat	ure				
C10	100 nF			Supply decoupling capacitor			
R45	4.7 k			Push button pull up			
R46	1 k			Output pull up			
R60				Delay time setting (def = 10 ms)			
PB1				Push button			
U22		TPS3838K33	TI	Supervisory circuit			
		GPIO expan	der				
C14, C15	100 nF			Supply decoupling capacitor			

UM2759 - Rev 2 page 10/18

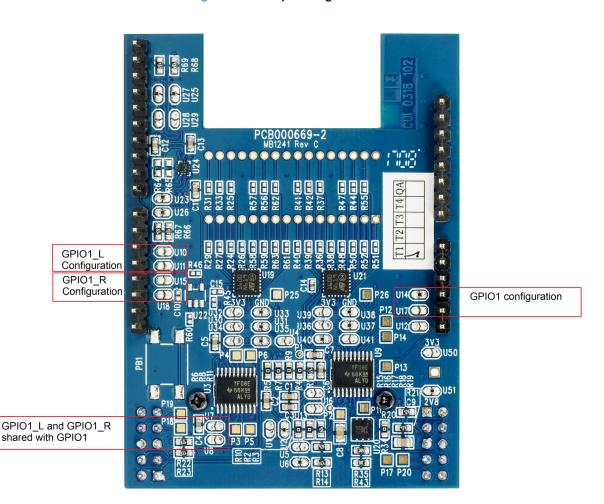


3.4 Solder drop configurations

Solder drops allow the following configurations of the X-NUCLEO-53L1A2 expansion board:

- If the developer wants to make an application with several expansion boards stacked and there is:
 - conflict with the microcontroller port allocation, the GPIO1 can be output on the CN8/A4 (U17 fitted) of the Arduino connector. The default configuration is that GPIO1 is output on the CN8/A2 (U14 fitted) of the Arduino connector.
 - conflict on the I2C addresses, the addresses of the STMPE1600 can be modified (the default addresses are A2, A1, A0, 000, and 001).
- If the developer wants to connect breakout boards (see Figure 5. Interrupt configurations) to the X-NUCLEO-53L1A2 expansion board:
 - the VL53L1 interrupt of the left breakout board can be output on the CN5/D9 (U10 fitted) or CN5/D8 (U11 fitted) of the Arduino connector. By default, the U10 and U11 are not fitted.
 - the VL53L1 interrupt of the right breakout board can be output on the CN9/D4 (U15 fitted) or CN9/D2 (U18 fitted) of the Arduino connector. By default, the U15 and U18 are not fitted.
 - the VL53L1 interrupt of the left and right breakout boards, GPIO1_L and GPIO1_R, can be shared with the VL53L1 interrupt on the main board, GPIO1, by fitting U7 and U8 solder drops. By default U7 and U8 are not fitted.

Figure 5. Interrupt configurations

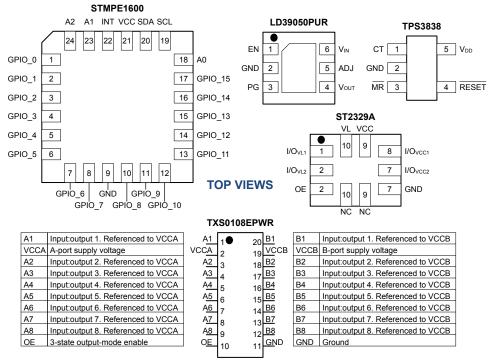


UM2759 - Rev 2 page 11/18



3.5 Integrated device pinning

Figure 6. Integrated device pinning



UM2759 - Rev 2 page 12/18



4 VL53L1 breakout board

The VL53L1 breakout boards are supplied at 2.8 V by the regulator present on the X-NUCLEO-53L1A2 expansion board.

Figure 7. VL53L1 breakout board

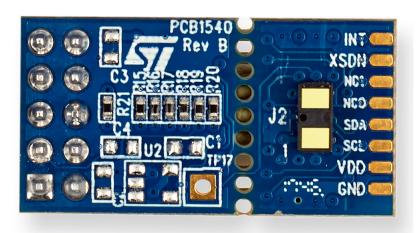
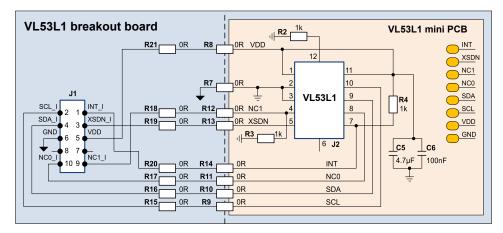


Figure 8. VL53L1 breakout board schematic

VL53L1						
AVDDVCSEL 1 12 GND4						
AVSSVCSEL	2	11	AVDD			
GND	3	10	SCL			
GND2	4	9	SDA			
XSHUT	5	8	DNC			
GND3*	6	7	GPIO1 (INT)			

* Could be or N.C. or Gounded



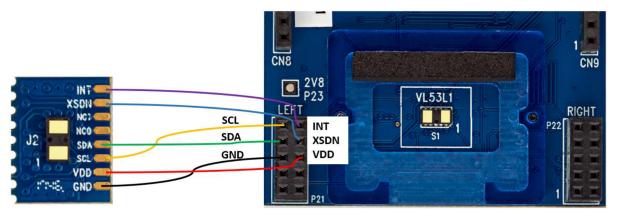
The VL53L1 breakout board can be directly plugged onto the X-NUCLEO-53L1A2 expansion board through the two 10-pin connectors or connected to the board through flying leads.

When connected through flying leads, developers should break off the mini PCB from the breakout board, and use only the VL53L1 mini PCB which is easier to integrate into customer devices, because of its small size.

UM2759 - Rev 2 page 13/18



Figure 9. VL53L1 mini PCB flying lead connection to X-NUCLEO-53L1A2 expansion board



UM2759 - Rev 2 page 14/18



5 Safety

5.1 Electrostatic precaution

The user should exercise electrostatic precautions, including using ground straps when using the X-NUCLEO-53L1A2 expansion board. Failure to prevent electrostatic discharge could damage the device.

Figure 10. Electrostatic logo



5.2 Laser considerations

The VL53L1 contains a laser emitter and corresponding drive circuitry. The laser output is designed to remain within Class 1 laser safety limits under all reasonably foreseeable conditions including single faults, in compliance with the IEC 60825-1:2014 (third edition). The laser output remains within Class 1 limits as long as STMicroelectronic's recommended device settings are used and the operating conditions specified in the datasheet are respected. The laser output power must not be increased by any means and no optics should be used with the intention of focusing the laser beam.

Figure 11. Class 1 laser product label



UM2759 - Rev 2 page 15/18



Revision history

Table 6. Document revision history

Date	Version	Changes
10-Sep-2020	1	Initial release
23-Apr-2021	2	Updated Figure 2. X-NUCLEO-53L1A2 expansion board schematic diagram

UM2759 - Rev 2 page 16/18



Contents

1	Overview					
2	Document references					
3		UCLEO-53L1A2 expansion board				
	3.1	Description	6			
	3.2	Electrical schematic				
	3.3	List of materials	10			
	3.4	Solder drop configurations	11			
	3.5	Integrated device pinning	12			
4	VL5	53L1 breakout board				
5	Safe	ety	15			
	5.1	Electrostatic precaution	15			
	5.2	Laser considerations				
Rev	ision	history	16			
Coi	ntents	S				



IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, please refer to www.st.com/trademarks. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2021 STMicroelectronics - All rights reserved

UM2759 - Rev 2 page 18/18